SMD2920Series

Positive Thermal Coefficient

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Description

The 2920 series provides surfaces mount resettable overcurrent protection with holding current from 0.3A to 7.0A.This series is suitable for applications with higher holding currant and higher working voltage up to 60V.

Features

* I(hold):0.3~7.0A
* Very high voltage surge capabilities
* Available in lead-free version
* Fast response to fault current
* RoHS compliant,Lead– Free and Halogen-Kree
* Low resistance
* Compact design saves board space
* Compatible with high temperature solders

Device Schematic

Applications

* USB peripherals
* Disk drives
* CD-ROMs
* General electronics
* Disk drives
* Set-top-box and HDMI
* Mobile Internet Device(MID)
* PDAs / digital cameras
* Game console port protection
* Plug and play protection for motherboards and peripherals
* Mobile phones - battery and port protection

Ordering Information

Part Number	HalogenFree	Packaging Option	Quantity	Quantity& Packing Codes
SMD2920P×××TF	Yes	Tape and Reel	1500	YR

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Type Number	I_{hold}	I_{trip}	V_{max}	Maximum Time to Trip		I_{max}	$P_{d\,typ}$	Ri_{min}	$R1_{max}$	Package	Package Dimensions (mm)						
											A		B		C		D
	A	A	V_{DC}	Current A	Time (Sec.)	A	W	Ω	Ω		min	max	min	max	min	max	min
SMD2920P030TF	0.3	0.6	60	1.5	3	10	1.5	0.6	4.8	2920	6.73	7.98	4.8	5.44	0.6	1.2	0.3
SMD2920P050TF	0.5	1	60	2.5	4	10	1.5	0.18	1.4	2920	6.73	7.98	4.8	5.44	0.6	1.2	0.3
SMD2920P075TF	0.75	1.5	33	8	0.3	40	1.5	0.1	1	2920	6.73	7.98	4.8	5.44	0.7	1.3	0.3
SMD2920P075TF/60	0.75	1.5	60	8	0.3	40	1.5	0.1	1	2920	6.73	7.98	4.8	5.44	0.7	1.3	0.3
SMD2920P100TF	1.1	2.2	33	8	0.5	40	1.5	0.065	0.41	2920	6.73	7.98	4.8	5.44	0.4	1	0.3
SMD2920P125TF	1.25	2.5	33	8	2	40	1.5	0.05	0.25	2920	6.73	7.98	4.8	5.44	0.4	1	0.3
SMD2920P150TF	1.5	3	33	8	2	40	1.5	0.035	0.23	2920	6.73	7.98	4.8	5.44	0.5	1.3	0.3
SMD2920P185TF	1.85	3.7	33	8	2.5	40	1.5	0.03	0.15	2920	6.73	7.98	4.8	5.44	0.7	1.4	0.3
SMD2920P200TF	2	4	16	8	4.5	40	1.5	0.02	0.12	2920	6.73	7.98	4.8	5.44	0.7	1.4	0.3
SMD2920P200TF/24	2	4	24	8	4.5	40	1.5	0.02	0.12	2920	6.73	7.98	4.8	5.44	0.7	1.4	0.3
SMD2920P200TF/30	2	4	30	8	4.5	40	1.5	0.02	0.12	2920	6.73	7.98	4.8	5.44	0.7	1.4	0.3
SMD2920P200TF/33	2	4	33	8	4.5	40	1.5	0.02	0.12	2920	6.73	7.98	4.8	5.44	0.7	1.4	0.3
SMD2920P250TF	2.5	5	16	8	16	40	1.5	0.02	0.085	2920	6.73	7.98	4.8	5.44	0.7	1.4	0.3
SMD2920P250TF/24	2.5	5	24	8	16	40	1.5	0.02	0.085	2920	6.73	7.98	4.8	5.44	0.7	1.4	0.3
SMD2920P260TF	2.6	5.2	6	8	10	40	1.5	0.014	0.075	2920	6.73	7.98	4.8	5.44	0.7	1.4	0.3
SMD2920P260TF/16	2.6	5.2	16	8	10	40	1.5	0.014	0.075	2920	6.73	7.98	4.8	5.44	0.7	1.4	0.3
SMD2920P300TF/6	3	6	6	8	20	40	1.5	0.012	0.048	2920	6.73	7.98	4.8	5.44	0.6	1.2	0.3
SMD2920P300TF/16	3	6	16	8	20	40	1.5	0.012	0.048	2920	6.73	7.98	4.8	5.44	0.6	1.2	0.3
SMD2920P400TF	4	8	16	20	4.0	40	1.5	0.008	0.04	2920	6.73	7.98	4.8	5.44	1	1.6	0.3
SMD2920P400TF/12	4	8	12	20	4.0	40	1.5	0.008	0.04	2920	6.73	7.98	4.8	5.44	1	1.6	0.3
SMD2920P400TF/24	4	8	24	20	4.0	40	1.5	0.008	0.04	2920	6.73	7.98	4.8	5.44	1	1.6	0.3
SMD2920P500TF	5	10	6	25	5.0	40	1.5	0.005	0.031	2920	6.73	7.98	4.8	5.44	1	1.6	0.3
SMD2920P500TF/12	5	10	12	25	5.0	40	1.5	0.005	0.031	2920	6.73	7.98	4.8	5.44	1	1.6	0.3
SMD2920P600TF	6	12	6	25	6.0	40	1.5	0.004	0.02	2920	6.73	7.98	4.8	5.44	1	1.6	0.3
SMD2920P700TF	7	14	6	25	6.0	40	1.5	0.0025	0.01	2920	6.73	7.98	4.8	5.44	1	1.6	0.3

I_{hold} = Hold current: maximum current device will pass without tripping in 25ºC still air.
I_{trip} = Trip current: minimum current at which the device will trip in 25 ºC still air.
V_{max} = Maximum voltage device can withstand without damage at rated current (I_{max})
I_{max} = Maximum fault current device can withstand without damage at rated voltage (V_{max})
$P_{d\,typ}$ = Typical power dissipated from device when in the tripped state at 25 ºC still air.
Ri min/max = Minimum/Maximum device resistance prior to tripping at 25°C.
$R1_{max}$ = Maximum device resistance is measured one hour post reflow.

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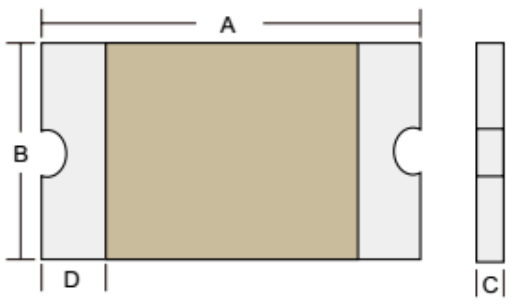
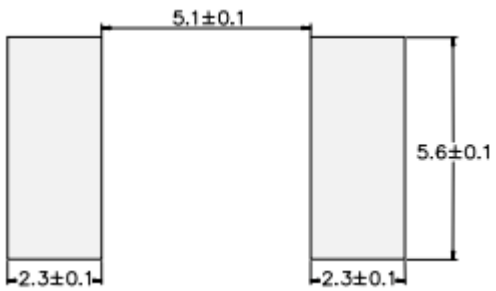
Part Number	Ambient Operation Temperature								
	-40 °C	-20 °C	0 °C	25 °C	40 °C	50 °C	60 °C	70 °C	85 °C
SMD2920P030TF	0.45	0.40	0.35	0.30	0.25	0.23	0.20	0.17	0.14
SMD2920P050TF	0.76	0.67	0.59	0.50	0.42	0.38	0.33	0.29	0.23
SMD2920P075TF	1.13	1.01	0.88	0.75	0.62	0.56	0.50	0.44	0.34
SMD2920P075TF/60	1.13	1.01	0.88	0.75	0.62	0.56	0.50	0.44	0.34
SMD2920P100TF	1.66	1.47	1.29	1.10	0.91	0.83	0.73	0.64	0.50
SMD2920P125TF	1.89	1.68	1.46	1.25	1.04	0.94	0.83	0.73	0.56
SMD2920P150TF	2.27	2.01	1.76	1.50	1.25	1.13	1.00	0.87	0.74
SMD2920P185TF	2.80	2.47	2.17	1.85	1.54	1.39	1.22	1.07	0.85
SMD2920P200TF	3.02	2.68	2.34	2.00	1.66	1.50	1.32	1.16	0.90
SMD2920P200TF/24	3.02	2.68	2.34	2.00	1.66	1.50	1.32	1.16	0.90
SMD2920P200TF/30	3.02	2.68	2.34	2.00	1.66	1.50	1.32	1.16	0.90
SMD2920P200TF/33	3.02	2.68	2.34	2.00	1.66	1.50	1.32	1.16	0.90
SMD2920P250TF	3.78	3.35	2.93	2.50	2.08	1.88	1.65	1.45	1.13
SMD2920P250TF/24	3.78	3.35	2.93	2.50	2.08	1.88	1.65	1.45	1.13
SMD2920P260TF	3.64	3.25	2.91	2.60	2.26	2.08	1.95	1.74	1.13
SMD2920P260TF/16	3.64	3.25	2.91	2.60	2.26	2.08	1.95	1.74	1.13
SMD2920P300TF	4.53	4.02	3.51	3.00	2.52	2.26	1.99	1.75	1.34
SMD2920P300TF/16	4.53	4.02	3.51	3.00	2.52	2.26	1.99	1.75	1.34
SMD2920P400TF	6.04	5.36	4.68	4.00	3.36	3.01	2.65	2.33	1.79
SMD2920P400TF/12	6.04	5.36	4.68	4.00	3.36	3.01	2.65	2.33	1.79
SMD2920P400TF/24	6.04	5.36	4.68	4.00	3.36	3.01	2.65	2.33	1.79
SMD2920P500TF	7.55	6.70	5.85	5.00	4.20	3.77	3.32	2.92	2.23
SMD2920P500TF/12	7.55	6.70	5.85	5.00	4.20	3.77	3.32	2.92	2.23
SMD2920P600TF	8.60	7.70	6.80	6.00	4.95	4.60	4.06	3.65	3.15
SMD2920P700TF	10.03	8.98	7.93	7.00	5.77	5.36	4.73	4.26	3.68

Lead style code

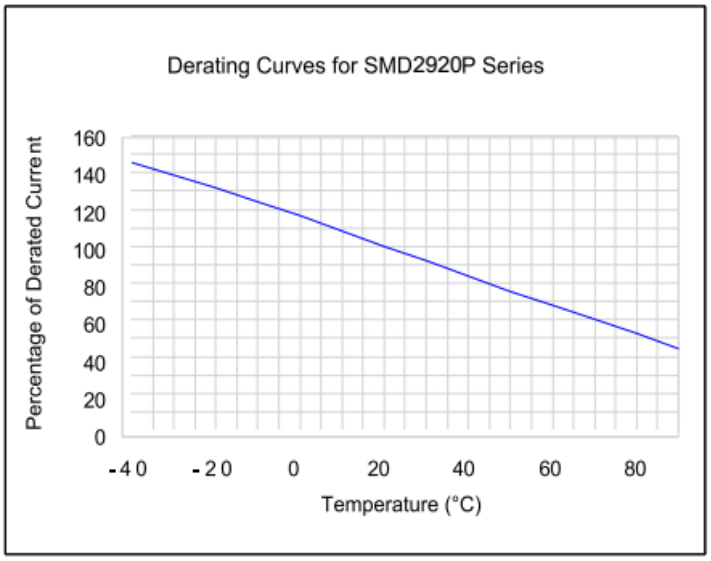


Recommended Pad Layout（mm）

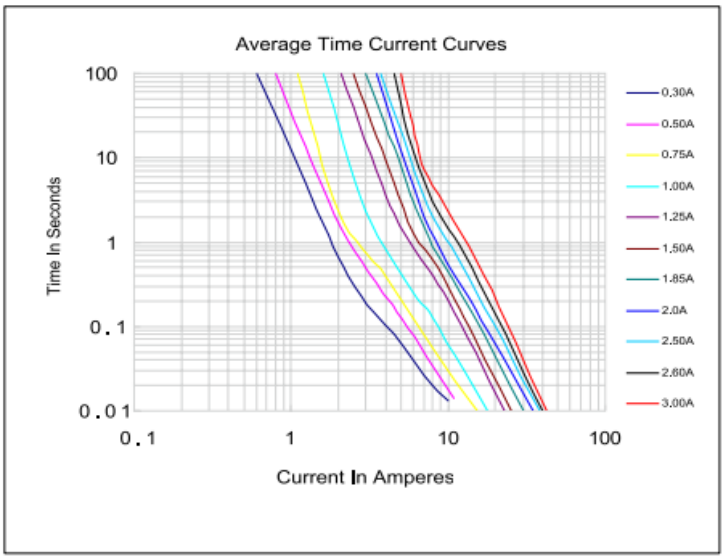


Typical Performance Characteristics

Thermal Derating Curve



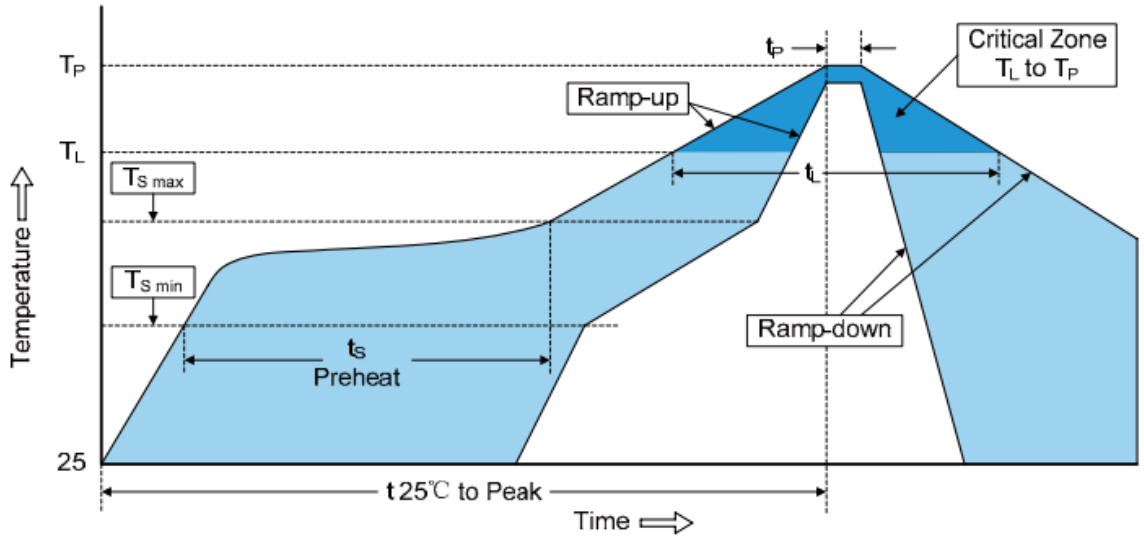
Average Time-Current Curve



Environmental Specifications

Test	Conditions	Resistance change
Passive aging	+85°C, 1000 hrs.	±5% typical
Humidity aging	+85°C, 85% R.H. , 168 hours	±5% typical
Thermal shock	+85°C to -40°C, 20 times	±33% typical
Resistance to solvent	MIL-STD-202,Method 215	No change
Vibration	MIL-STD-202,Method 201	No change
Ambient operating conditions : - 40 °C to +85 °C		
Maximum surface temperature of the device in the tripped state is 125 °C		

Soldering Parameters

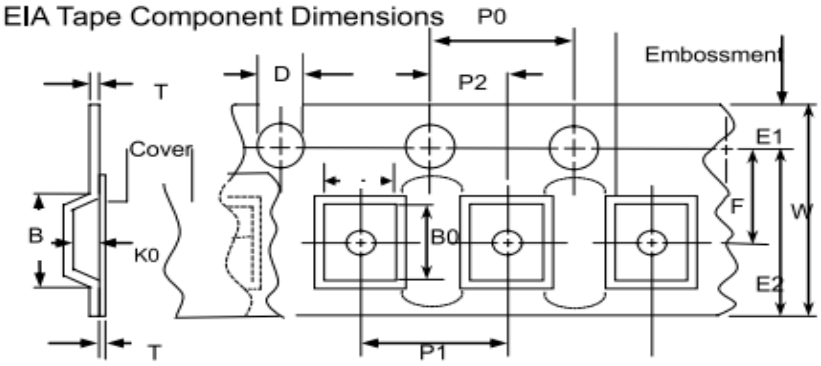


Profile Feature	Pb-Free Assembly
Average ramp-up rate ($T_{S\ max}$ to T_P)	3℃/second max.
Preheat -Temperature Min ($T_{S\ min}$) -Temperature Max ($T_{S\ max}$) -Time (min to max) ($T_{S\ min}$ to $T_{S\ max}$)	 150℃ 200℃ 60-180 seconds
Time maintained above: -Temperature (T_L) -Time (t_L)	 217℃ 60-150 seconds
Peak Temperature (T_P)	260℃
Time within 5℃ of actual Peak Temperature (t_P)	20-40 seconds
Ramp-down Rate	6℃/second max.
Time 25℃ to Peak Temperature	8 minutes max.
Storage Condition	0℃~35℃, ≤70%RH

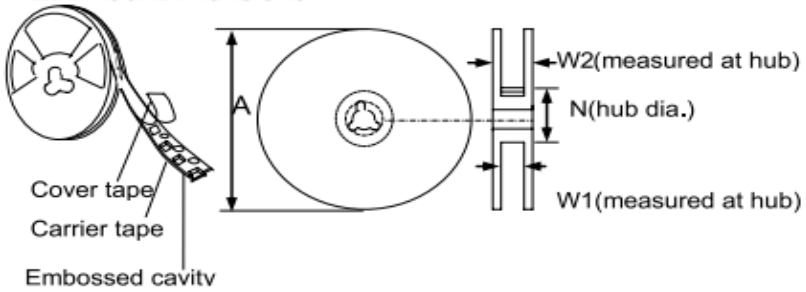
Tape and Reel Specificatons

Governing Specifications	EIA 481-1
W	16.0 ± 0.3
P0	4.0 ± 0.10
P1	8.0 ± 0.10
P2	2.0 ± 0.05
A0	5.70 ± 0.10
B0	8.00 ± 0.10
B1max.	12.10
D0	1.50 + 0.1, -0
F	7.5 ± 0.05
E1	1.75 ± 0.10
E2min.	14.25
T	0.6
T1max.	0.1
K0	0.8± 0.1
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	60
W1	16.4± 0.5
W2	22.4 ± 0.5

EIA Tape Component Dimensions



EIA Reel Dimensions



S	M	D	X	X	X	X	P	X	X	X	T	F	/	-	-

- Surface Mount Device
- Device size code
- Polytronics Symbol
- Current Rating
- T: Thin Version (Optional)
- F: Lead-free
- Special Voltage Rating (Optional)

NOTICE

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